Fast Turn-off Intelligent Rectifier

ZCC6908

DESCRIPTION

The ZCC6908 is a Low-Drop Diode Emulator IC that, combined with an external switch, replaces Schottky diodes in high-efficiency Flyback converters. The chip regulates the forward drop of an external Synchronous Rectifier (SR) MOSFET to about 40mV and switches it off as soon as the voltage becomes negative. ZCC6908 can generate its own supply voltage for battery charging applications with low output voltage or high side rectification applications. A programmable ringing detection circuitry prevents ZCC6908 false turn-on during DCM and Quasi-Resonant operations.

ZCC6908 is available in space saving TSOT23-6 packages.

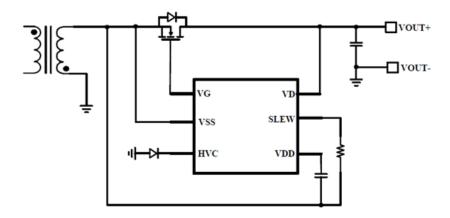
FEATURES

- Operates in a wide output voltage range down to 0V
- Self-supplying for operation with low output voltage and/or high-side rectification without an auxiliary winding
- Works with 12V Standard and 5V Logic Level SR MOSFETS
- Compatible with Energy Star, 1W Standby Requirements
- <30ns Fast Turn-off and Turn-on Delay</p>
- <100uA Quiescent Current</p>
- Supports DCM, Quasi-Resonant and CCM Operations
- Supports both High-side and Low-side Rectification
- Power Savings of Up to 1.5W in a Typical Notebook Adapter
- TSOT23-6 Package Available

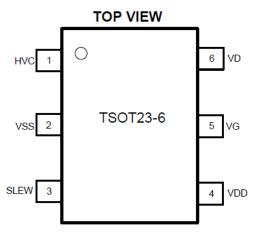
APPLICATIONS

- Industrial Power Systems
- Distributed Power Systems
- Battery Powered Systems
- Flyback Converters

TYPICAL APPLICATION



PACKAGE REFERENCE



ABSOLUTE MAXIMUM RATINGS

V _{DD} to Vss	–0.3V to +14V
V _G to V _{SS}	–0.3V to +14V
V _D , HVC to Vss	–1V to + 80V
SLEW to VSS	–0.3V to +6.5V
Continuous Power Dissipation (TA = +25°C)	
Junction Temperature	150°C
Lead Temperature (Solder)	260°C
Storage Temperature	–55°C to +150°C

Recommended Operation Conditions

VDD to VSS	3.6 to 13V
Maximum Junction Temp. (TJ)	+125°C

Thermal Resistance

TSOT23-6	220	110	$^{\circ}$ C	/\Λ/
100120-0	220	1 10	\mathbf{C}	/ V V

ELECTRICAL CHARACTERISTICS

VDD=5V. TJ=-40°C~125°C, Min & Max are guaranteed by characterization, typical is tested under 25°C, unless otherwise specified.

Parameter	Symbol	Conditions	Min	Тур	Max	Units
SUPPLY MANAGEMENT S	SUPPLY MANAGEMENT SECTION					
VDD UVLO Rising				3.8		V
V _{DD} UVLO Hysteresis			0.1	0.2	0.35	V
VDD Maximum Charging	11/00	VDD=7V,HVC=40V		70		A
Current	IVDD	VDD=4V, VD=30V		40		mA
VDD Regulation Voltage		VD=12V,HVC=12V		9		V
		HVC=3V, VD=12V		5		V

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Page			VDD=9V,				
CC			CLOAD=2.2nF,		2.9		
VDD=5V,	Operating Current	ICC	Fsw=100kHz				mΛ
Rew=100kHz	Operating Current	ICC	VDD=5V,				ША
Quiescent Current Iq(VDD) VDD=5V 100 130 uA Shutdown Current ISD(VDD) VDD=UVLO-0.05V 100 uA CONTROL CIRCUITRY SECTION Vss-Vb Forward Regulation Voltage Vfwd 40 mV Turn-On Threshold (Vbs) VLL-DS -86 mV Turn Off Threshold (VSS-VD) TDon CLOAD = 2.2nF 30 ns Turn-On Delay TDon CLOAD = 2.2nF 30 ns Turn Off Delay TDoff CLOAD = 2.2nF 30 ns Turn On Blanking Time TB-ON CLOAD = 2.2nF 1.97 us Turn Off Blanking Vbs Threshold VB-OFF 2 3 V Turn On Slew Rate Detection Timer Rslew=100kohm, Vds from 2.5V step down. 60 ns ns GATE DRIVER SECTION VG (Low) VG-L ILOAD=10mA or 100mA 0.02 0.1 V VG (High) VG-H ILOAD=10mA or 100mA VDD V Maximum Sour			CLOAD=2.2nF,		1.72		
Shutdown Current ISD(VDD) VDD=UVLO-0.05V 100 UA			Fsw=100kHz				
CONTROL CIRCUITRY SECTION Vss-Vb Forward Regulation Voltage Vfwd 40 mV Turn-On Threshold (Vbs) VLL-DS -86 mV Turn Off Threshold (VSS-VD) 0 mV Turn-On Delay TDon CLOAD = 2.2nF 30 ns Turn-Off Delay TDoff CLOAD = 2.2nF 30 ns Turn On Blanking Time TB-ON CLOAD = 2.2nF 1.97 us Turn Off Blanking Vbs Threshold VB-OFF 2 3 V Turn On Slew Rate Detection Timer Rslew=100kohm, Vds from 2.5V step down. 60 ns GATE DRIVER SECTION VG-L ILOAD=10mA or 100mA 0.02 0.1 V VG (Low) VG-H ILOAD=10mA or 100mA VDD V Maximum Source Current 0.5 A Maximum Sink Current 3 A	Quiescent Current	lq(VDD)	VDD=5V		100	130	uA
Vss-Vb Forward Regulation Voltage Vfwd 40 mV Turn-On Threshold (Vbs) VLL-DS -86 mV Turn Off Threshold (VSS-VD) 0 mV Turn-On Delay TDon CLOAD = 2.2nF 30 ns Turn-Off Delay TDoff CLOAD = 2.2nF 30 ns Turn On Blanking Time TB-ON CLOAD = 2.2nF 1.97 us Turn Off Blanking Vbs Threshold VB-OFF 2 3 V Turn On Slew Rate Detection Timer Rslew=100kohm, Vds from 2.5V step down. 60 ns GATE DRIVER SECTION VG-L ILOAD=10mA or 100mA 0.02 0.1 V VG (Low) VG-H ILOAD=10mA or 100mA VDD V Maximum Source Current 100mA 0.5 A Maximum Sink Current A A	Shutdown Current	ISD(VDD)	VDD=UVLO-0.05V			100	uA
Regulation Voltage Vfwd 40 mV Turn-On Threshold (Vbs) VLL-DS -86 mV Turn Off Threshold (VSS-VD) 0 mV Turn-On Delay TDon CLOAD = 2.2nF 30 ns Turn-Off Delay TDoff CLOAD = 2.2nF 30 ns Turn On Blanking Time TB-ON CLOAD = 2.2nF 1.97 us Turn Off Blanking Vbs VB-OFF 2 3 V Turn On Slew Rate Detection Timer Rslew=100kohm, Vds from 2.5V step down. 60 ns GATE DRIVER SECTION VG-L ILOAD=10mA or 100mA 0.02 0.1 V VG (High) VG-H ILOAD=10mA or 100mA VDD V Maximum Source Current 0.5 A Maximum Sink Current 3 A	CONTROL CIRCUITRY SE	CTION					
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Turn Off Threshold (VSS-VD) TDon CLOAD = 2.2nF 30 ns Turn-On Delay TDon CLOAD = 2.2nF 30 ns Turn-Off Delay TDoff CLOAD = 2.2nF 30 ns Turn On Blanking Time TB-ON CLOAD = 2.2nF 1.97 us Turn Off Blanking Vos Threshold VB-OFF 2 3 V Turn On Slew Rate Detection Timer Rslew=100kohm, Vds from 2.5V step down. 60 ns GATE DRIVER SECTION VG-L ILOAD=10mA or 100mA 0.02 0.1 V VG (High) VG-H ILOAD=10mA or 100mA VDD V Maximum Source Current 0.5 A Maximum Sink Current A A	Regulation Voltage	Viwu			40		IIIV
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Threshold (VSS-VD) Turn-On Delay TDon CLOAD = 2.2nF 30 ns Turn-Off Delay TDoff CLOAD = 2.2nF 30 ns Turn Off Delay TB-ON CLOAD = 2.2nF 1.97 us Turn Off Blanking Vbs Threshold VB-OFF 2 3 V Turn Off Blanking Vbs Threshold Rslew=100kohm, Vds from 2.5V step down. 60 ns GATE DRIVER SECTION ILOAD=10mA or 100mA 0.02 0.1 V VG (Low) VG-H ILOAD=10mA or 100mA VDD V Maximum Source Current ILOAD=10mA or 100mA VDD V Maximum Sink Current 3 A	Turn Off				0		m\/
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Turn On Blanking Time TB-ON CLOAD = 2.2nF 1.97 us Turn Off Blanking Vos Threshold VB-OFF 2 3 V Turn On Slew Rate Detection Timer Rslew=100kohm, Vds from 2.5V step down. 60 ns GATE DRIVER SECTION VG (Low) VG-L ILOAD=10mA or 100mA 0.02 0.1 V VG (High) VG-H ILOAD=10mA or 100mA VDD V Maximum Source Current 0.5 A Maximum Sink Current 3 A	Turn-On Delay	TDon	CLOAD = 2.2nF		30		ns
Turn Off Blanking Vos Threshold VB-OFF 2 3 V Turn On Slew Rate Detection Timer Rslew=100kohm, Vds from 2.5V step down. 60 ns GATE DRIVER SECTION VG (Low) VG-L ILOAD=10mA or 100mA 0.02 0.1 V VG (High) VG-H ILOAD=10mA or 100mA VDD V Maximum Source Current Maximum Sink Current 0.5 A Maximum Sink Current 3 A	Turn-Off Delay	TDoff	CLOAD = 2.2nF		30		ns
Threshold Rslew=100kohm, Vds from 2.5V step down. 60 ns GATE DRIVER SECTION VG (Low) VG-L ILOAD=10mA or 100mA 0.02 0.1 V VG (High) VG-H ILOAD=10mA or 100mA VDD V Maximum Source Current Maximum Sink Current 0.5 A	Turn On Blanking Time	TB-ON	CLOAD = 2.2nF		1.97		us
Threshold Rslew=100kohm, 60 ns Detection Timer Vds from 2.5V step down. 60 ns GATE DRIVER SECTION VG (Low) VG-L ILOAD=10mA or 100mA 0.02 0.1 V VG (High) VG-H ILOAD=10mA or 100mA VDD V Maximum Source Current 0.5 A Maximum Sink Current 3 A	Turn Off Blanking VDS	VB-OFF		2		2	\/
Detection Timer Vds from 2.5V step down. 60 ns GATE DRIVER SECTION VG (Low) VG-L ILOAD=10mA or 100mA 0.02 0.1 V VG (High) VG-H ILOAD=10mA or 100mA VDD V Maximum Source Current 0.5 A Maximum Sink Current 3 A	Threshold			2		3	V
down. GATE DRIVER SECTION VG (Low) VG-L ILOAD=10mA or 100mA 0.02 0.1 V VG (High) VG-H ILOAD=10mA or 100mA VDD V Maximum Source Current 0.5 A Maximum Sink Current 3 A	Turn On Slew Rate		Rslew=100kohm,				
GATE DRIVER SECTION VG (Low) VG-L ILOAD=10mA or 100mA 0.02 0.1 V VG (High) VG-H ILOAD=10mA or 100mA VDD V Maximum Source Current 0.5 A Maximum Sink Current 3 A	Detection Timer		Vds from 2.5V step		60		ns
VG (Low) VG-L ILOAD=10mA or 100mA 0.02 0.1 V VG (High) VG-H ILOAD=10mA or 100mA VDD V Maximum Source Current 0.5 A Maximum Sink Current 3 A			down.				
VG (High) VG-H ILOAD=10mA or 100mA VDD V Maximum Source Current 0.5 A Maximum Sink Current 3 A	GATE DRIVER SECTION						
100mA	VG (Low)	VG-L	ILOAD=10mA or		0.02	0.1	V
Maximum Source Current 100mA VDD V Maximum Sink Current 0.5 A A A A			100mA		0.02	0.1	V
Maximum Source Current 0.5 A Maximum Sink Current 3 A	VG (High)	VG-H	ILOAD=10mA or		VDD		V
Maximum Sink Current 3 A			100mA		VUU		V
	Maximum Source Current				0.5		Α
Pull Down Impedance Same as VG(Low) 1 Ω	Maximum Sink Current				3		Α
	Pull Down Impedance		Same as VG(Low)		1		Ω

PIN FUNCTIONS

Pin#	Name	Description
1	HVC	HV Linear Regulator Input
2	VSS	Ground, also used as FET source sense reference for VD
3	SLEW	Programming for turn on signal slew rate detection. To prevent SR controller false turn on by ringing below turn on threshold at VD in DCM and QR modes, any signal slower than pre-set slew rate is not going to turn on VG
4	VDD	Linear Regulator Output, supply ZCC6908
5	VG	Gate drive output
6	VD	FET drain voltage sense

BLOCK DIAGRAM

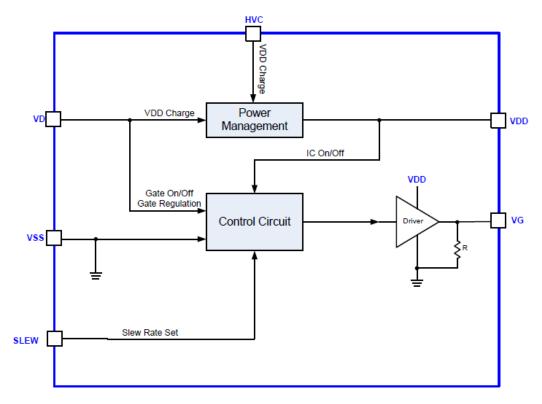


Figure 1—Functional Block Diagram

OPERATION

The ZCC6908 supports operation in DCM and Quasi-Resonant Flyback converters as well as in CCM mode. The control circuitry controls the gate in forward mode and will turn the gate off when SR MOSFET current drops to zero.

Start-up and VDD Generation

HVC is the input for linear regulator which output is VDD. VDD is regulated at 9V which supplies ZCC6908 including VG. Here HVC can be a DC voltage such as VOUT for low side rectification or an AC voltage such as Drain of SR MOSFET. When HVC is above 4.7V, linear regulator's maximum charging current is 70mA to charge the external 1uF capacitor at VDD. VDD is regulated to 9V when HVC is above 9.7V. Then VDD follows HVC with 0.7V dropout (i.e. VDD=HVC- 0.7V) until HVC drops to 4.7V. Once HVC drops below 4.7V, a 40mA current source from VD will charge up VDD and regulate at 5V.

Under-Voltage Lockout (UVLO)

When VDD is increased above 3.8V, ZCC6908 goes out of UVLO and is enabled. ZCC6908 goes into sleep mode and VG keeps at low once VDD drops below 3.6V.

Turn-on Phase

While VDS (VD-VSS) falls through 2V, a turn-on timer starts. This turn-on timer can be programmed by external resistor at SLEW pin. If VDS reaches -86mV turn-on threshold from 2V within this time set by the timer, MOSFET will be turned on after a turn-on delay which is around 30ns for ZCC6908 (as showed in Fig.2). If VDS across -86mV after the timer times off, gate voltage VG is going to stay off. This turn-on timer is to prevent ZCC6908 from false turn-on due to ringing from DCM and QR

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operations. TSLEW can be programmed by the following equation:

$$T_{SLEW} = R_{SLEW} \times \frac{20ns}{100k\Omega}$$

Turn On Blanking

The control circuitry contains a blanking function. When it pulls the MOSFET on, it makes sure that the on state at least lasts for some time. The turn on blanking time is ~1.97us to prevent accidently turn-off because of ringing, during which the turn off threshold is blanked (as showed in Fig.2) and sink ability is limited at ~2.5mA. However if Vds not only reaches turn-off threshold of 0mV, but also all the way up to 2-3V, VG is pulled low immediately even though ~1.97us minimum on time has not been satisfied.

Conduction Phase

When VDS rises above the forward voltage drop (- 40mV) according to the decrease of switching current, ZCC6908 will pull down the gate voltage level to make the on resistance of synchronous MOSFET larger to ease the rise of VDS.

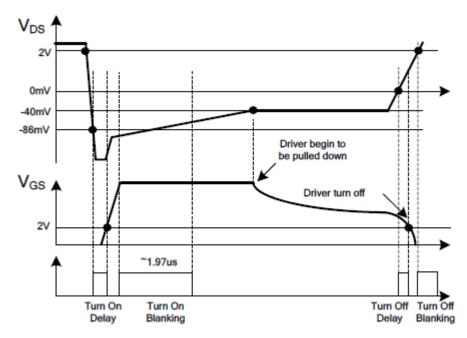


Figure 2—Turn on/off Timing Diagram

See Fig.2, with this control scheme, VDS is adjusted to be around -40mV even when the current through the MOSFET is fairly low, this function can make the driver voltage at very low level when synchronous MOSFET is going to be turned off, which boosts the turn off speed.

Turn-off Phase

When VDS rises to trigger the turn off threshold (0mV), the gate voltage is pulled to zero after a very short turn off delay which is 15ns, see Fig.2.

Turn-off Blanking

After gate driver VG is pulled to zero by VDS touching the turn-off threshold (0mV), a turn-off blanking time will be applied during which the gate driver signal is latched off, the turn-off blanking will be removed when VDS voltage rises to above 2V (as showed in Fig.2)

Typical System Implementations

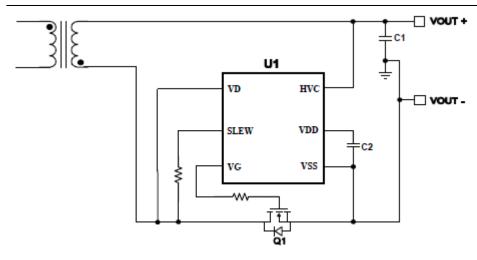


Figure 3— ZCC6908 in Low-Side Rectification

Fig.3 shows the typical system implementation for the IC power supply derived from output voltage VOUT, which is available in low-side rectification.

Since HVC operating range is from 0V to 180V, ZCC6908 can support most applications even when VOUT is down to 0V for low-side rectification. When VOUT (HVC) is above 9.7V, VDD will be regulated at 9V. VDD follows VOUT (HVC) with 0.7V dropout until VOUT is below 4.7V. Once VOUT drops below 4.7V, another 40mA current source from Drain of SR MOSFET Q1 (VD) is going to charge VDD up and regulate at 5V again. If ZCC6908 is used for high-side rectification, there are two ways to do self-supply shown in Fig.4 and Fig.5. Fig.4 shows HVC is connected to secondary ground through an external diode. Here VDD is generated from HVC and regulated at 9V. Maximum voltage at HVC is:

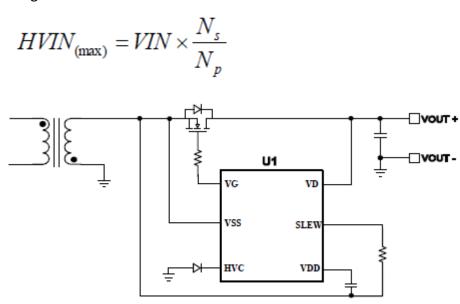


Figure 4— ZCC6908 in High-Side Rectification

Fig.5 works the same as described above when HVC is below 4.7V, since HVC is shorted to VSS.Here VDD is generated by VD and regulated at 5V in this configuration.

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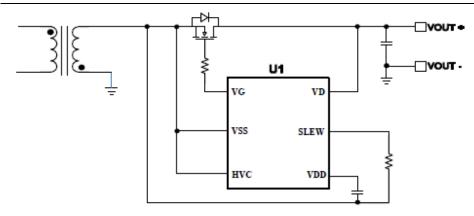


Figure 5— ZCC6908 in High-Side Rectification

SR MOSFET Selection

The Power MOSFET selection proved to be a tradeoff between RDS(ON) and Qg. To achieve higher efficiency, the MOSFET with smaller RDS(ON) is always preferred, while Qg is usually larger with RDS(ON) smaller, which makes the turn-on/off speed lower and lead to larger power loss including driver loss. For ZCC6908, because VDS is adjusted at ~-40mV during the driving period when switching current is fairly small, the MOSFET with too low RDS(ON) is not recommend, because the gate driver will started to be pulled to low when VDS=-ISDxRDS(ON) becomes larger than -40mV, which makes MOSFET's RDS(ON) no contribution to conduction loss then (conduction loss PCON=-VDSxISD≈ISDx40mV).

Fig.6 shows the typical waveform of QR flyback. Assume 50% duty cycle and the output current is IOUT.

To achieve fairly high usage of the MOSFET's RDS(ON), it is expected that the MOSFET be fully turned on at least 50% of the SR conduction period:

$$Vds = -Ic \times Ron = -2 \cdot I_{OUT} \times Ron \le -V f w d$$

Where VDS is Drain-Source voltage of the MOSFET and Vfwd is the forward voltage threshold of ZCC6908, which is ~40mV.

So the MOSFET's RDS(ON) is recommended to be no lower than ~20/IOUT (m Ω). (For example, for 5A application, the RDS(ON) of the MOSFET is recommended to be no lower than 4m Ω).

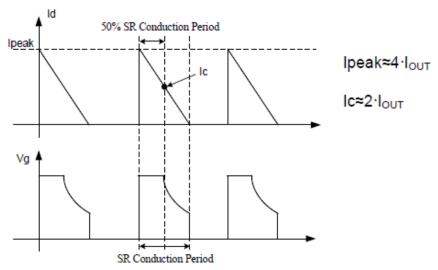


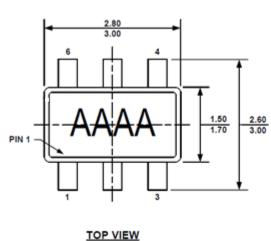
Figure 6—Synchronous Rectification typical waveforms in QR Flyback

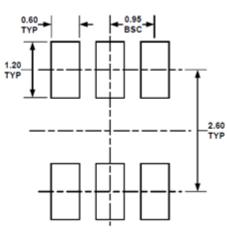
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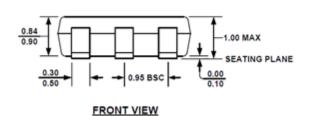
PACKAGE INFORMATION

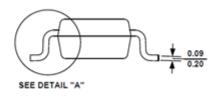
TSOT23-6





RECOMMENDED LAND PATTERN





SIDE VIEW

GAUGE PLANE
0.25 BSC

0.30
0°.8°

0.50

DETAIL "A"